## DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next

	to my name.	-	
	I believe I am the original, first an listed below) or an original, first a listed below) of the subject matter w is sought on the invention entitled	nd joint inventor (1f hich is claimed and f	plural names are
	the specification of which		
-	(check one) is attached hereto was filed on (if	as App. Ser	. No and
-	I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.		
	I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).		
	I hereby claim foreign priority beneficode, §119 of any foreign application certificate listed below and have als application for patent or inventor's before that of the application on whi	n(s) for patent or inv so identified below an certificate having a	ventor's Ny foreign filing date
N	Prior Foreign Application(s) P 61-311697 Japan 26. (Number) (Country) (Day/	Pri Dec., 1986 Month/Year Filed)	ority Claimed Yes No X Yes No
	(Number) (Country) (Day/	Month/Year Filed)	
11/2	(Number) (Country) (Day/	Month/Year Filed)	Yes No
in the	I hereby claim the benefit under Title United States application(s) listed to matter of each of the claims of this prior United States application in the paragraph of Title 35, United States disclose material information as defined Regulations, §1.56(a) which occurred application and the national or PCT in	pelow and, insofar as application is not dine manner provided by Code, §112, I acknowlined in Title 37, Code between the filing da	the subject sclosed in the the first edge the duty to of Federal ate of the prior
U	application:	•	
Ø	(App. Ser. No.) (Filing Date)	(Status-patented, per	nding, abandoned)
$\eta$	(App. Ser. No.) (Filing Date)	(Status-patented, per	nding, abandoned)
Y	I hereby appoint the following attorn this application and to transact all Office connected therewith: 30/Louis Weinstein, Reg. No. 20.477, Weinstein, Reg. Reg. Reg. No. 20.477, Weinstein, Reg. Reg. Reg. Reg. Reg. Reg. Reg. Reg.	business in the Pater instein & Kimmelman	nt and Trademark
	557-9797		- 1. I

Address all correspondence to : 601 Weinstein & Kimme 602 Two Mellon Bank (702 Philadelphia, PA 70/ Suite 2410

(cont)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor: Youii Watanabe
Inventor's signature: Youji Watanabe Date: June 28, 198
Residence: Sagami hara-Shi, Kanagawa-Ken, Japan J P Citizenship: Japan Post Office Address: 330-3, Kamitsuruma, Sagami hara-Shi, Kanagawa-Ken, Japan
Full name of second joint inventor, if any Horn Matsuzaki
Second Inventor's signature: Minoru Matsuzaki Date: June 28, 1988
Residence: Hachioji-Shi, Tokyo, Japan JPK Citizenship: Japan
Post Office Address: 60-5-903, Teramachi, Hachioji-Shi, Tokyo, Japan
Full name of third joint inventor, if any: Junichi Itoh
Third Inventor's signature: Junichi Itoh Date: June 28, 1988
Residence: <u>Hachioji-Shi</u> , Tokyo, Japan <b>JPX</b> Citizenship: Japan
Post Office Address: 7-14-11, Owada-Chou, Hachioji-Shi, Tokyo, Japan